

PRODUCT SPECIFICATION

1.4” OLED Display Module MODEL: YDP OLED W 140



- < ◇ > Preliminary Specification
- < ◆ > Finally Specification

CUSTOMER’S APPROVAL	
CUSTOMER :	
SIGNATURE:	DATE:

APPROVED BY	PM REVIEWED	PD REVIEWED	PREPARED BY

knitter-switch

Revision History

Revision	Date	Originator	Detail	Remarks
1.0	2022.07.27	ZFY	Initial Release	

Table of Contents

No.	Item	Page
1.	Module Parameter.....	4
2.	Absolute Maximum Ratings.....	4
3.	Interface Pins Definition	5
4.	Optics & Electrical Characteristics	6
4.1.	Optics Characteristics.....	6
4.2.	DC Characteristics.....	6
4.3.	INTERFACE TIMING CHART	7
5.	Outgoing Quality Control Specifications	12
5.1.	Environment Required.....	12
5.2.	Sampling Plan	12
5.3.	Criteria & Acceptable Quality Level	12
6.	Reliability Specification.....	16
6.1.	Contents of Reliability Tests	16
6.2.	Failure Check Standard	16
7.	Precautions When Using These OLED Display Modules	17
7.1.	Handling Precautions	17
7.2.	Storage Precautions	18
7.3.	Designing Precautions	18
7.4.	Precautions when disposing of the OLED display modules.....	18
7.5.	Other Precautions.....	19
7.6.	Warranty	19
8.	Outline Drawing.....	20

1. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	1.4"	
Resolution	160 x 160	Pixels
Module Outline	29(H) x 31.9(V) x 1.427(T) (Note1)	mm
Active Area	25(H) x 24.815(V)	mm
Pixel Size	156(H) x 155(V)	um
Interface	8-bit 68XX/80XX Parallel Interface 4-SPI Interface 3-SPI Interface IIC Interface	
With or without touch panel	Without	
Driver IC	CH1120	-
Display color	white	
Weight	TBD	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

2. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Display	VCC	-0.3	15	V	1,2
Supply Voltage	VDD	-0.3	3.5	V	1,2
Operating Temperature	T _{OP}	-40	85	°C	
Storage Temperature	T _{STG}	-40	85	°C	3
Life Time (150 cd/m ²)		10000	-	hour	4
Life Time (120 cd/m ²)		30000	-	hour	4
Life Time (80 cd/m ²)		50000	-	hour	4

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

Note 3: The defined temperature ranges do not include the polarizer. The maximum withstood temperature of the polarizer should be 80°C.

Note 4: VCC = 13.0V, Ta = 25°C, 50% Checkerboard.

Software configuration follows Section 4.4 Initialization.

End of lifetime is specified as 50% of initial brightness reached. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

3. Interface Pins Definition

No.	Symbol	Function																								
1	NC_TP-GND	No connection																								
2	NC_TP-SCL	No connection																								
3	NC_TP-SDA	No connection																								
4	NC_TP-RES	No connection																								
5	NC_TP-INT	No connection																								
6	NC_TP-VDD	No connection																								
7	VSS	Ground of Logic Circuit																								
8	VCC(VPP)	Power Supply for OEL Panel																								
9	VCOMH	Voltage Output High Level for COM Signal																								
10	VDD	Power Supply for Logic																								
11	VLSS(VSS)	Ground of Analog Circuit																								
12	CS#	Chip Select																								
13	RES#	Power Reset for Controller and Driver																								
14	D/C#(A0)	Data/Command Control																								
15	R/W#	Read/Write Select or Write																								
16	RD#	Read/Write Enable or Read																								
17	D0	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2C mode is selected, D2 & D1 should be tied together and serve as SDAout & SDAin in application and D0 is the serial clock input SCL. Unused pins must be connected to VSS except for D2 in serial mode.																								
18	D1																									
19	D2																									
20	D3																									
21	D4																									
22	D5																									
23	D6																									
24	D7																									
25	BS0(IM0)	Communicating Protocol Select <table><tr><td></td><td>BS0</td><td>BS1</td><td>BS2</td></tr><tr><td>I2C</td><td>0</td><td>1</td><td>0</td></tr><tr><td>3-SPI</td><td>0</td><td>0</td><td>1</td></tr><tr><td>4-SPI</td><td>0</td><td>0</td><td>0</td></tr><tr><td>8-bit 68XX parallel</td><td>1</td><td>0</td><td>0</td></tr><tr><td>8-bit 80XX parallel</td><td>0</td><td>1</td><td>1</td></tr></table>		BS0	BS1	BS2	I2C	0	1	0	3-SPI	0	0	1	4-SPI	0	0	0	8-bit 68XX parallel	1	0	0	8-bit 80XX parallel	0	1	1
	BS0		BS1	BS2																						
I2C	0		1	0																						
3-SPI	0		0	1																						
4-SPI	0		0	0																						
8-bit 68XX parallel	1		0	0																						
8-bit 80XX parallel	0	1	1																							
26	BS1(IM1)																									
27	BS2(IM2)																									
28	VSL	Discharge voltage level pad.																								
29	IREF	Current Reference for Brightness Adjustment																								
30	NC	No connection																								

4. Optics & Electrical Characteristics

4.1. Optics Characteristics

Characteristics	Symbol	Conditions	Min	Typ	Max	Unit
Luminance	Lbr		90	110	-	cd/m2
C.I.E. (White)	(x)	C.I.E. 1931	0.24	0.28	0.32	
	(y)		0.28	0.32	0.36	
Dark Room Contrast	CR		2000:1	-	-	
Viewing Angle			160	-	-	degree

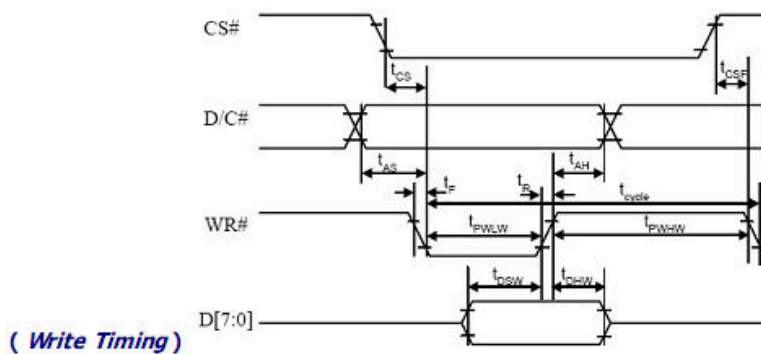
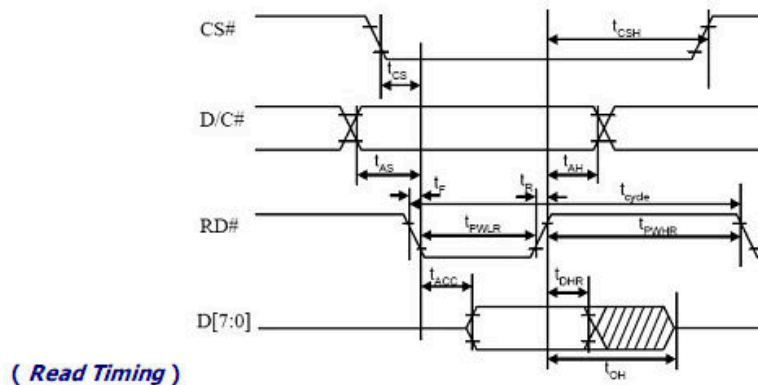
4.2. DC Characteristics

Characteristics	Symbol	Min	Typ	Max	Unit
Analog power supply	VCC	12.5	13	13.5	V
Digital power supply	VDD	1.65	2.8	3.5	V
Operating Current for VDD	IDD	-	-	600	μA
Operating Current for VCC	ICC	-	47	65	μA
High Level Input	VIH	0.8×VDD	-	-	V
Low Level Input	VIL	-	-	0.2×VDD	V
High Level Output	VOH	0.8×VDD	-	-	V
Low Level Output	VOL	-	-	0.2×VDD	V

4.3. INTERFACE TIMING CHART

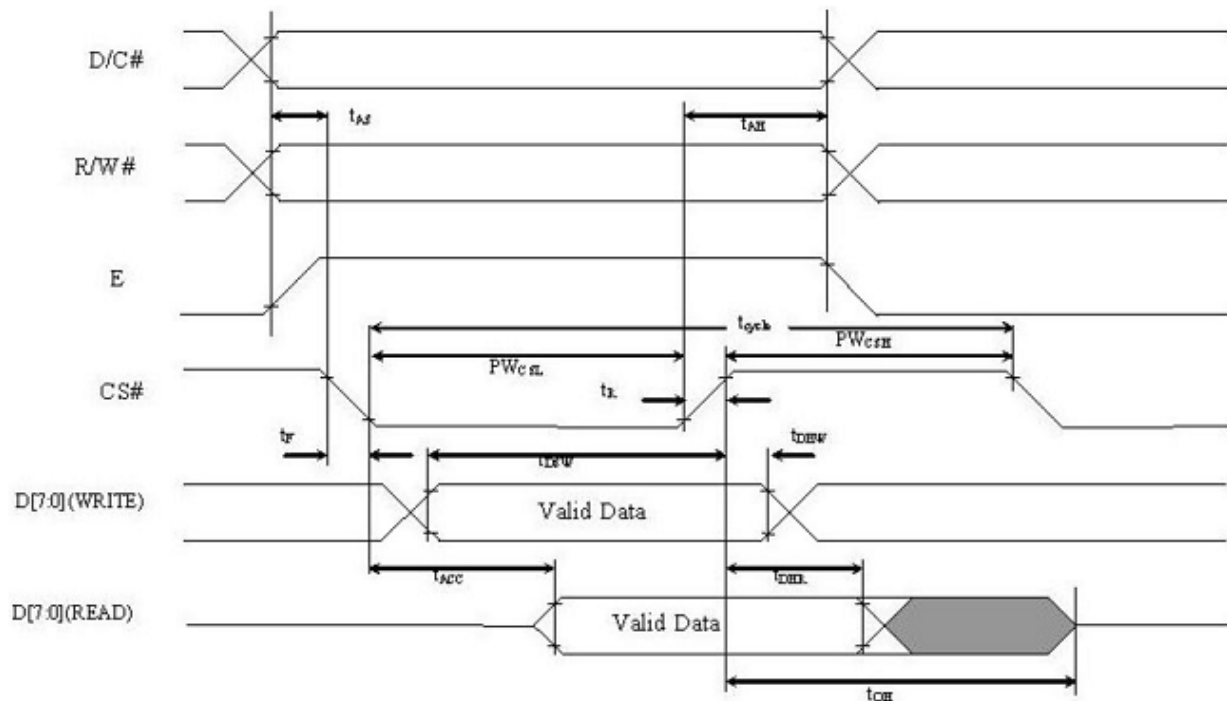
4.3.1. 8080-Series MCU Parallel Interface Timing Characteristics

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	ns
t_{AS}	Address Setup Time	0	-	ns
t_{AH}	Address Hold Time	0	-	ns
t_{DSW}	Write Data Setup Time	40	-	ns
t_{DHW}	Write Data Hold Time	10	-	ns
t_{DHR}	Read Data Hold Time	10	-	ns
t_{OH}	Output Disable Time	-	70	ns
t_{ACC}	Access Time	-	140	ns
t_{PWLr}	Read Low Time	150	-	ns
t_{PWLW}	Write Low Time	150	-	ns
t_{PWHr}	Read High Time	150	-	ns
t_{PWHW}	Write High Time	150	-	ns
t_{CS}	Chip Select Setup Time	0	-	ns
t_{CSH}	Chip Select Hold Time to Read Signal	20	-	ns
t_{CSF}	Chip Select Hold Time	20	-	ns
t_R	Rise Time	-	15	ns
t_F	Fall Time	-	15	ns



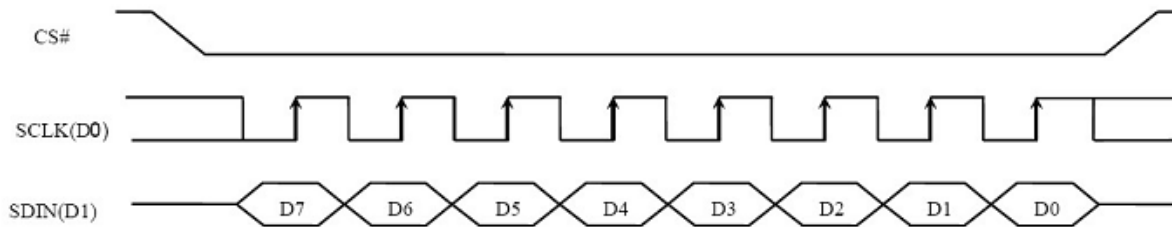
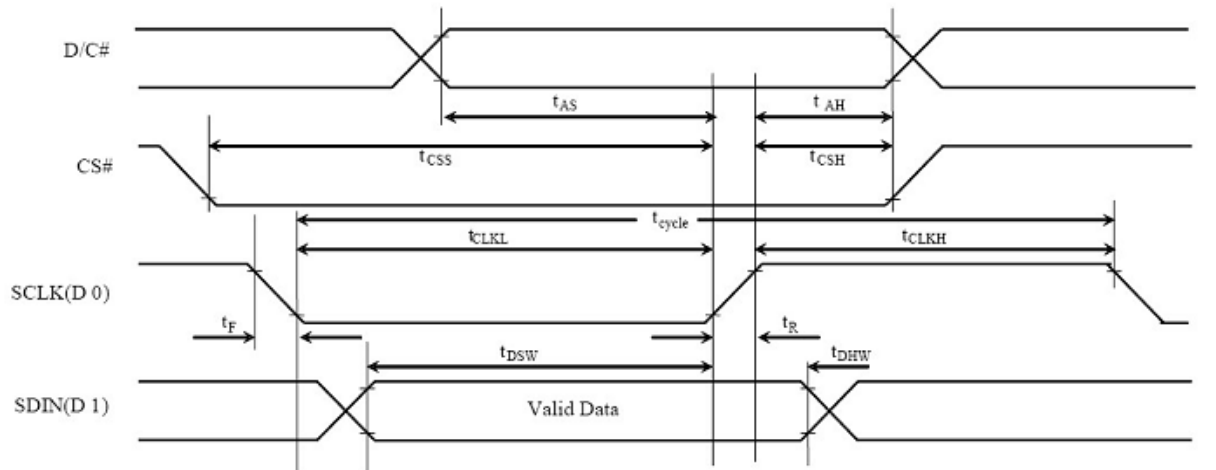
4.3.2. 6800-Series MCU Parallel Interface Timing Characteristics

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	ns
t_{AS}	Address Setup Time	0	-	ns
t_{AH}	Address Hold Time	0	-	ns
t_{DSW}	Write Data Setup Time	40	-	ns
t_{DHW}	Write Data Hold Time	10	-	ns
t_{DHR}	Read Data Hold Time	10	-	ns
t_{OH}	Output Disable Time	-	70	ns
t_{ACC}	Access Time	-	140	ns
PW_{CSL}	Chip Select Low Pulse Width (Read)	150	-	ns
	Chip Select Low Pulse width (Write)	150		
PW_{CSH}	Chip Select High Pulse Width (Read)	150	-	ns
	Chip Select High Pulse Width (Write)	150		
t_R	Rise Time	-	15	ns
t_F	Fall Time	-	15	ns



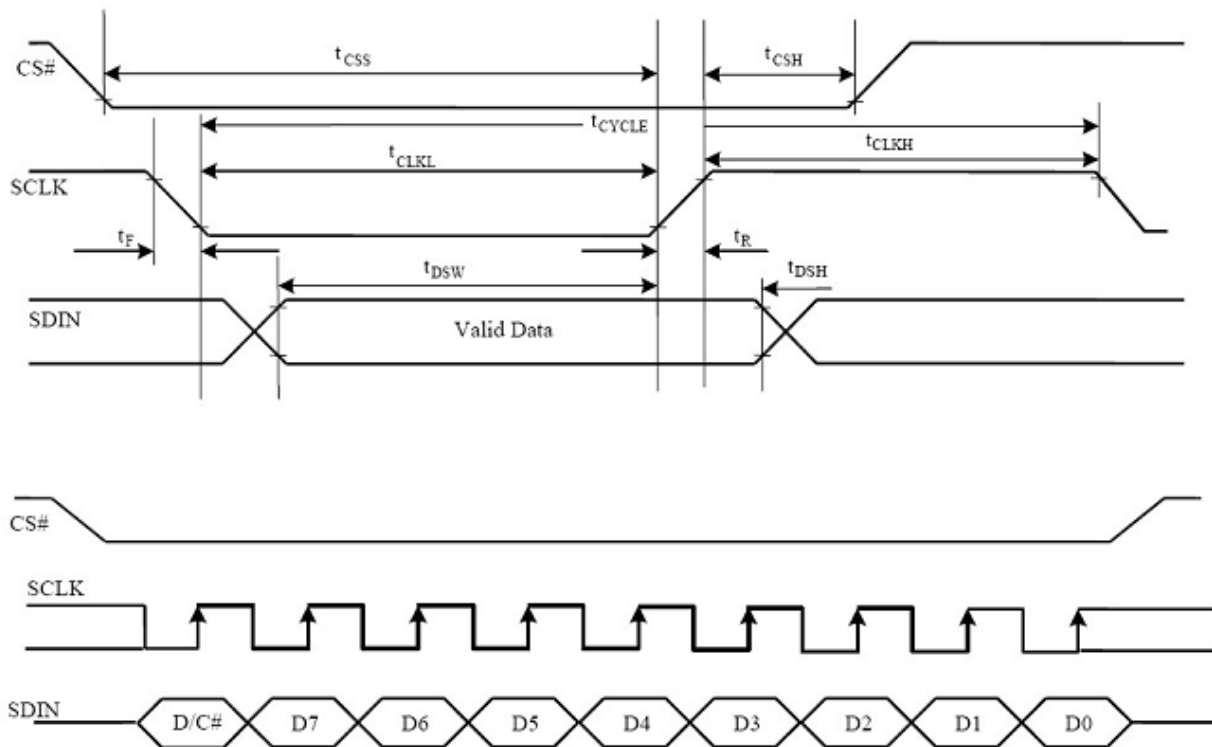
4.3.3. Serial Interface Timing Characteristics: (4-wire SPI)

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	50	-	ns
t_{AS}	Address Setup Time	30	-	ns
t_{AH}	Address Hold Time	30	-	ns
t_{CSS}	Chip Select Setup Time	20	-	ns
t_{CSH}	Chip Select Hold Time	20	-	ns
t_{DSW}	Write Data Setup Time	45	-	ns
t_{DHW}	Write Data Hold Time	12	-	ns
t_{CLKL}	Clock Low Time	20	-	ns
t_{CLKH}	Clock High Time	20	-	ns
t_R	Rise Time	-	3	ns
t_F	Fall Time	-	3	ns



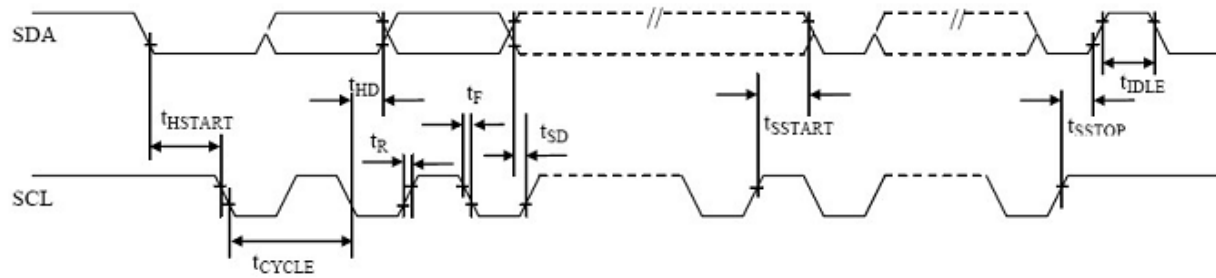
4.3.4. Serial Interface Timing Characteristics: (3-wire SPI)

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	50	-	ns
t_{css}	Chip Select Setup Time	20	-	ns
t_{csh}	Chip Select Hold Time	20	-	ns
t_{dsw}	Write Data Setup Time	45	-	ns
t_{dhw}	Write Data Hold Time	12	-	ns
t_{clkL}	Clock Low Time	20	-	ns
t_{clkH}	Clock High Time	20	-	ns
t_R	Rise Time	-	3	ns
t_F	Fall Time	-	3	ns



4.3.5. I2C Interface Timing Characteristics

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	2.5	-	μs
t_{HSTART}	Start Condition Hold Time	0.6	-	μs
t_{HD}	Data Hold Time (for "SDA _{OUT} " Pin)	0	-	ns
	Data Hold Time (for "SDA _{IN} " Pin)	100		
t_{SD}	Data Setup Time	100	-	ns
t_{SSTART}	Start Condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	μs
t_{SSTOP}	Stop Condition Setup Time	0.6	-	μs
t_{R}	Rise Time for Data and Clock Pin		300	ns
t_{F}	Fall Time for Data and Clock Pin		300	ns
t_{IDLE}	Idle Time before a New Transmission can Start	1.3	-	μs



5. Outgoing Quality Control Specifications

5.1. Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature:	$23 \pm 5^{\circ}\text{C}$
Humidity:	$55 \pm 15\% \text{ RH}$
Fluorescent Lamp:	30W
Distance between the Panel & Lamp:	$\geq 50\text{cm}$
Distance between the Panel & Eyes of the Inspector:	$\geq 30\text{cm}$
Finger glove (or finger cover) must be worn by the inspector.	
Inspection table or jig must be anti-electrostatic.	

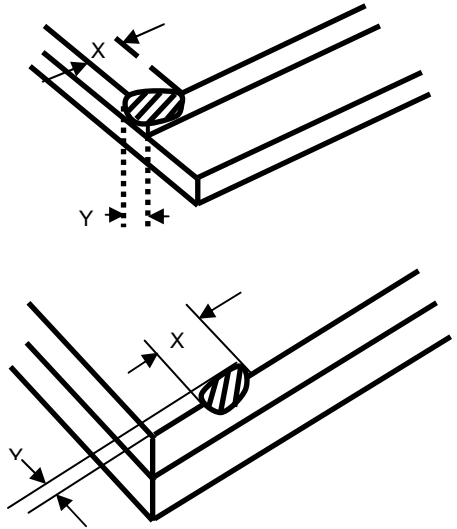
5.2. Sampling Plan

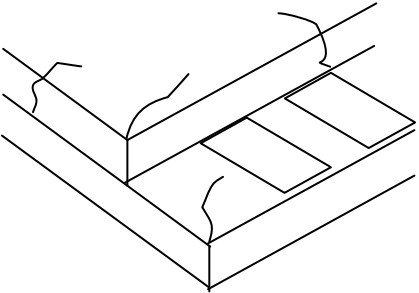

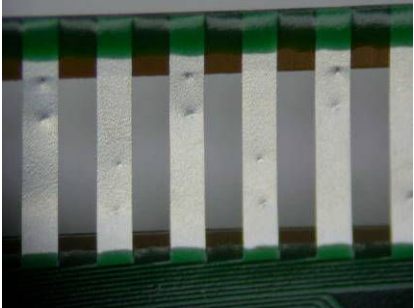
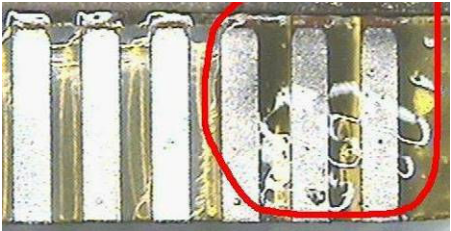
Level II, Normal Inspection, Single Sampling, MIL-STD-105E

5.3. Criteria & Acceptable Quality Level

Partition	AQL	Definition
Major	0.65	Defects in Pattern Check (Display On)
Minor	1.0	Defects in Cosmetic Check (Display Off)

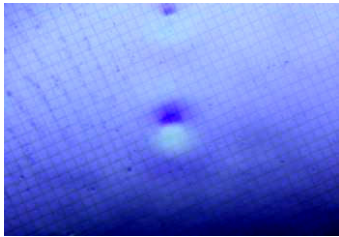
5.3.1. Cosmetic Check (Display Off) in Non-Active Area

Check Item	Classification	Criteria
Panel General Chipping	Minor	<p>$X > 6 \text{ mm}$ (Along with Edge) $Y > 1 \text{ mm}$ (Perpendicular to edge)</p> 

Panel Crack	Minor	<p>Any crack is not allowable.</p> 
Copper Exposed (Even Pin or Film)	Minor	Not Allowable by Naked Eye Inspection
Film or Trace Damage	Minor	
Terminal Lead Prober Mark	Acceptable	
Glue or Contamination on Pin (Couldn't Be Removed by Alcohol)	Minor	
Ink Marking on Back Side of panel (Exclude on Film)	Acceptable	Ignore for Any

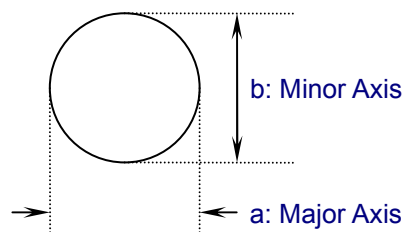
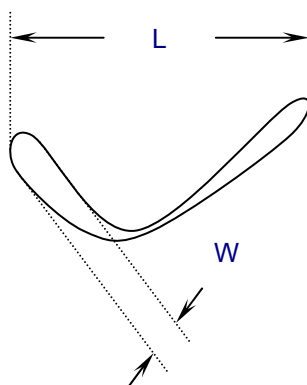
5.3.2. Cosmetic Check (Display Off) in Active Area

It is recommended to execute in clear room environment (class 10k) if actual in necessary.


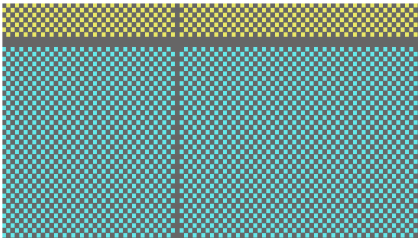
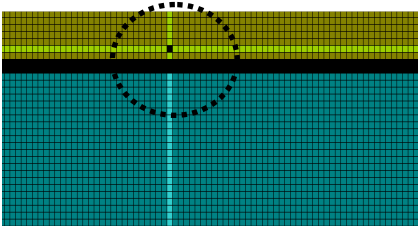
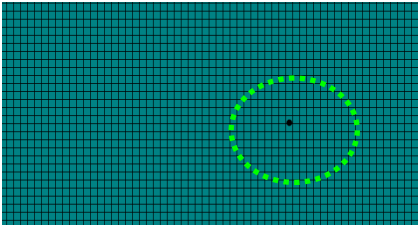
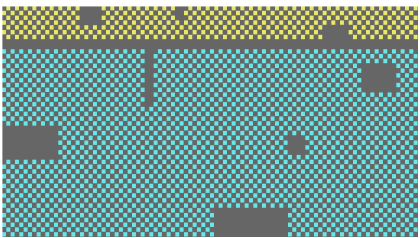
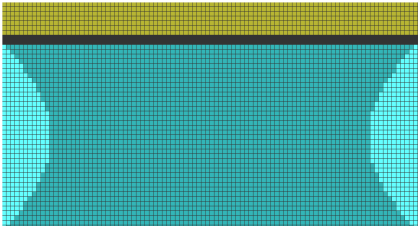
Check Item	Classification	Criteria
Any Dirt & Scratch on Polarizer's Protective Film	Acceptable	Ignore for not Affect the Polarizer
Scratches, Fiber, Line-Shape Defect (On Polarizer)	Minor	$W \leq 0.1$ Ignore $W > 0.1$ $L \leq 2$ $n \leq 1$ $L > 2$ $n = 0$
Dirt, Black Spot, Foreign Material, (On Polarizer)	Minor	$\Phi \leq 0.1$ Ignore $0.1 < \Phi \leq 0.25$ $n \leq 1$ $0.25 < \Phi$ $n = 0$
Dent, Bubbles, White spot (Any Transparent Spot on Polarizer)	Minor	$\Phi \leq 0.5$ → Ignore if no Influence on Display $0.5 < \Phi$ $n = 0$ 
Fingerprint, Flow Mark (On Polarizer)	Minor	Not Allowable

Note 1: Protective film should not be tear off when cosmetic check.

Note 2: Definition of W & L & Φ (Unit: mm): $\Phi = (a + b) / 2$



5.3.3. Pattern Check (Display On) in Active Area

Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	
Un-uniform	Major	

6. Reliability Specification

6.1. Contents of Reliability Tests

No	Item	Condition	Quantity
1	High Temperature Operating	70°C, 240Hrs	2
2	Low Temperature Operating	-40°C, 240Hrs	2
3	High Humidity	60°C, 90%RH, 120Hrs	2
4	High Temperature Storage	85°C, 240Hrs	2
5	Low Temperature Storage	-40°C, 240Hrs	2
6	Thermal Cycling Test	-40°C, 30min ~ 85°C, 30min, 24 cycles.	2

Note1. The samples used for the above tests do not include polarizer.

Note2. No moisture condensation is observed during tests.

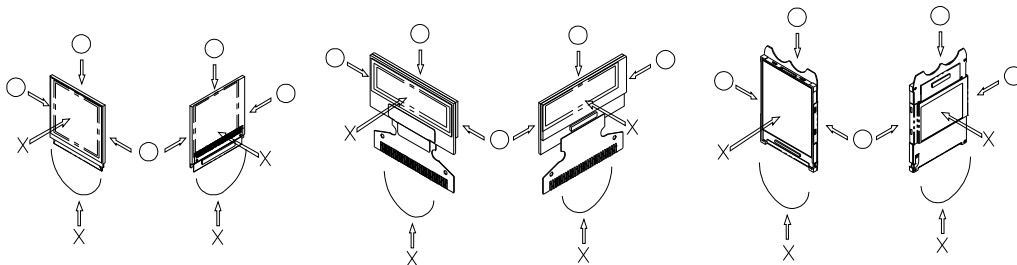
6.2. Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.

7. Precautions When Using These OLED Display Modules

7.1. Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- 5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalentNever try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the polarizer:
 - * Water
 - * Ketone
 - * Aromatic Solvents
- 6) Hold OLED display module very carefully when placing OLED display module into the system housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the driver IC and the surrounding molded sections.
 - 8) Do not disassemble nor modify the OLED display module.
 - 9) Do not apply input signals while the logic power is off.
 - 10) Pay sufficient attention to the working environments when handling OLED display modules to prevent occurrence of element breakage accidents by static electricity.
 - * Be sure to make human body grounding when handling OLED display modules.
 - * Be sure to ground tools to use or assembly such as soldering irons.
 - * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
 - * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
 - 11) Protection film is being applied to the surface of the display panel and removes the
-

protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).

- 12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

7.2. Storage Precautions

- 1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Newvision technology Co.,Ltd.)

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

- 2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

7.3. Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the V_{IL} and V_{IH} specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (V_{DD}). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OLED display module, fasten the external plastic housing section.
- 7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1316

*Connection (contact) to any other potential than the above may lead to rupture of the IC.

7.4. Precautions when disposing of the OLED display modules

Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

7.5. Other Precautions

- 1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- 2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
 - * Pins and electrodes
 - * Pattern layouts such as the FPC
- 3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
 - * Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
 - * Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- 4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

7.6. Warranty

The warranty period shall last twelve months from the date of delivery. Buyer shall be completed to assemble all the processes within the effective twelve months. We shall be liable for replacing any products which contain defective material or process which do not conform to the product specification, applicable drawings and specifications during the warranty period. All products must be preserved, handled and appearance to permit efficient handling during warranty period. The warranty coverage would be exclusive while the returned goods are out of the terms above.

8. Outline Drawing

